

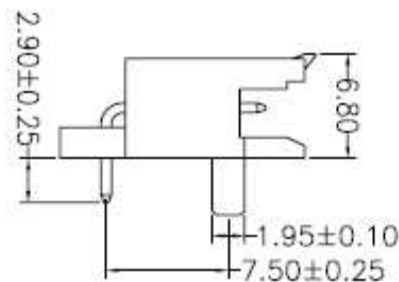
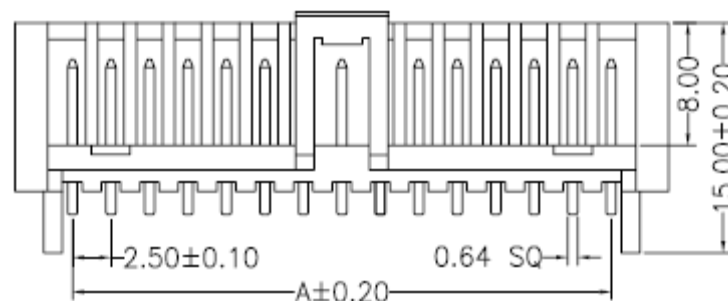
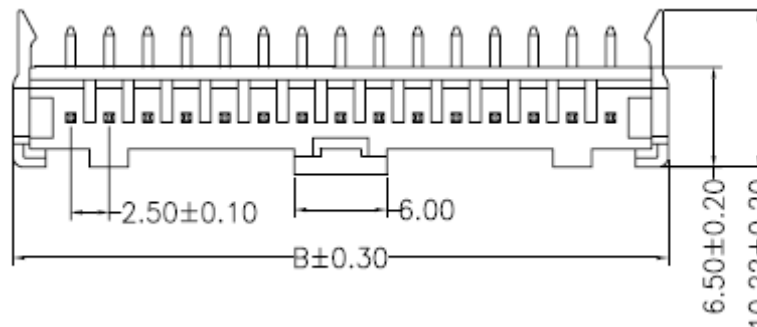
EDCON-COMPONENTS



Specifications

- Voltage Rating:
- Current Rating
- Operating Temperature
- Contact Resistance
- Withstanding Voltage
- Insulation Resistance
- Applicable Wire
- Applicable P.C.B
- Applicable FPC/FFC
- Solder Height
- Crimp Tensile Strength

Drawing (dimensions all into mm)



Terminal Assembly Drawing



Wafer Serie T68Pxxxx Pitch
2,50mm

Part No.: **T68P001**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	1 from 3	

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Dimension Informations about Wafer

Pos.	Dimension (mm)					
	A	B	C	D	E	F
2	2,50	10,00				
3	5,00	12,50				
4	7,50	15,00				
5	10,00	17,50				
6	12,50	20,00				
7	15,00	22,50				
8	17,50	25,00				
9	20,00	27,50				
10	22,50	30,00				
11	25,00	32,50				
12	27,50	35,00				
13	30,00	37,50				
14	32,50	40,00				
15	35,00	42,50				

Pos.	Dimension (mm)					
	A	B	C	D	E	F



Wafer Serie T68Pxxxx Pitch 2,50mm	
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EDCON-COMPONENTS



Ordering Informations

Serie	Number of Pos.	BodyColor	Contact Plating	Packing						
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T68P001	02	WH	T	BU						
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xx = Pos.	WH= White	T= Tin Plated (Standard)	BU= Bulk (Standard)							
	BG= Beige		TY= Tray Packing							
		G= Gold Flash Plated								



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